SPECIFICATIONS

CUSTOMER · CBE005

SAMPLE CODE · SNA800480T013IHC09

MASS PRODUCTION CODE . HNA800480T013IHC09

SAMPLE VERSION . 01

SPECIFICATIONS EDITION . 002

DRAWING NO. (Ver.) . LMD- HNA800480T013IHC09 (Ver.001)

PACKAGING NO. (Ver.) PKG- HNA800480T013IHC09 (Ver.001)

Customer Approved

Date:

Approved	Approved Checked		
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☐ Preliminary specification for design input

■ Specification for sample approval

POWERTIP 2020.02.03 TW RD APR

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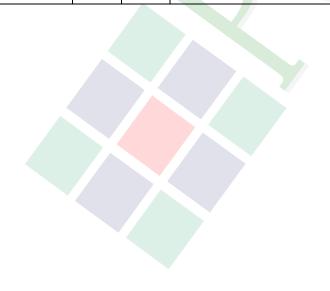
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History of Version

Date (mm / dd / yyyy)	Ver.	Edi.	Description	Page	Design by
11/25/2019	01	001	New Drawing.	_	Rex
02/03/2020	01	002	New Sample.	-	Rex





Contents

1. SPECIFICATIONS

- 1.1 Features
- 1.2 Mechanical Specifications
- 1.3 Absolute Maximum Ratings
- 1.4 DC Electrical Characteristics
- 1.5 Optical Characteristics

2. MODULE STRUCTURE

- 2.1 Counter Drawing
- 2.2 Interface Pin Description

3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart

4. RELIABILITY TEST

4.1 Reliability Test Condition

5. PRECAUTION RELATING PRODUCT HANDLING

- 5.1 Safety
- 5.2 Handling
- 5.3 Storage
- 5.4 Terms of Warranty

Appendix: 1.LCM Drawing



1. SPECIFICATIONS

1.1 Features

Hardware

CPU	RISC Processor	N32926 (ARM926EJ-S) 64MB DDR2 SDRAM	
	On Board Flash	1Gb NAND Flash	
Memory	External Storage *	1x Micro SD (max. 32G)	
I/O	USB	1x USB2.0 Device	
1/0	Serial	1 x UART	

LCD Display

Item	Standard Value
Display Resolution	800 * 3 (RGB) * 480 Dots
LCD Type	a-Si TFT , Normally white , Transmissive type
Touch Panel	Projected Capacitive Touch
Screen size(inch)	7.0 inch
Color configuration	RGB Vertical Strip
Backlight Type	White LED B/L
	THIS PRODUCT CONFORMS THE ROHS OF PTC
ROHS	Detail information please refer website : http://www.powertip.com.tw/news_detail.php?Key=1&cID=1

Note:

- 1. Support PWM Signal Output. (5kHz, Duty Cycle: 256 Step)
- 2. Support JPEG Codec.
- 3. Support H.264 & MJPEG Codec
- 4. Support Video Data Processor (VPE)
- 5. Support RTC



PS:

This product built-in Powertip communication protocol system firmware. It manipulates the GUI contents that generated by Powertip Graphic Editor software.

1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension	186.8(W) x 110.56(L) x 16.5 max. (H)	
Active Area	154.08 (W) x 85.92(L)	mm

Note: For detailed information please refer to drawing



1.3 Absolute Maximum Ratings

Item	Symbol	Condition	Min.	Max.	Unit	Remark
Power Supply	VIN	GND=0	-0.3	6.0	V	
Operating Temperature	Top (Ts)	Note 1	-20	70	°C	-
Storage Temperature	T _{ST} (Ta)	Note 2	-30	80	°C	

The absolute maximum rating values of this product are not allowed to be exceeded at any times. Should a module be used with any of the absolute maximum ratings exceeded, the characteristics of the module may not be recovered, or in an extreme case, the product may be permanently destroyed.

Note 1: Ts is the temperature of panel's surface.

Note 2: Ta is the ambient temperature of samples.

1.4 DC Electrical Characteristics

Ta = 25°℃

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Power Supply Voltage	VIN	-	4.8	5.0	5.5	V
Power Supply Voltage of RTC	VBAT	-	2.0	-	3.6	V
Power Supply Current *1	IIN	VIN = 5.0V	ı	1.5	2.0	Α
Power Consumption of System	PIN	VIN = 5.0V	ı	ı	10.0	W
IO High-Level input voltage	VIH	-	2.0	1	V3V3+0.3	V
IO Low-Level input voltage	VIL	-	1	1	0.8	V
IO High-Level output voltage	Vон	-	2.4		-	V
IO Low-Level output voltage	Vol	-	-	-	0.4	V



1.5 Optical Characteristics

Ta=25°C

Item		Symbol	Condition	Min.	Тур.	Max.	unit	-
Response time	Tr+Tf	25 ℃	-	-	25	50	ms	-
	Тор	θΥ+			60	-		
Viewing angle	Bottom	θΥ-	CR ≥ 10		60	-	Dog	Note 4
Viewing angle	Left	θX-			60	1	Deg.	Note 4
	Right	θX+			60	-		
Contrast rati	0	CR		500	600	-	1	Note 3
	White	Х		0.23	0.28	0.33		
		Υ	(Ta = 25°C θX , θY = 0°	0.27	0.32	0.37		Noted
Color of CIE	Red	Х		0.52	0.57	0.62		
Color of CIE		Y		0.31	0.36	0.41		
Coordinate (With B/L & T/P)	Green	Х	ΘX , $\Theta Y = 0^{\circ}$	0.29	0.34	0.39	-	Note1
(WILLI DIL & TIF)		Y		0.55	0.60	0.65		
	Dluc	Х		0.09	0.14	0.19		
	Blue	Y	A	0.02	0.07	0.12		
Average Brightness Pattern=white display (With T/P)*1		IV	PWM="High" (Duty=100%)	680	850	-	cd/m2	Note1
Uniformity (With T/P)*2	, ,		PWM="High" (Duty=100%)	70	-	-	%	Note1



Note 1:

*1 : △B=B(min) / B(max) * 100%

*2 : Measurement Condition for Optical Characteristics:

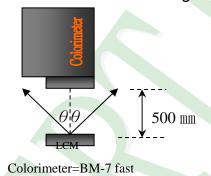
a: Environment: 25°C±5°C / 60±20%R.H, no wind, dark room below 10 Lux at typical lamp current and typical operating frequency.

b : Measurement Distance: $500 \pm 50 \text{ mm}$, $(\theta = 0^\circ)$

c: Equipment: TOPCON BM-7 fast, (field 1°), after 10 minutes operation.

d: The uncertainty of the C.I.E coordinate measurement ±0.01, Average Brightness ± 4%





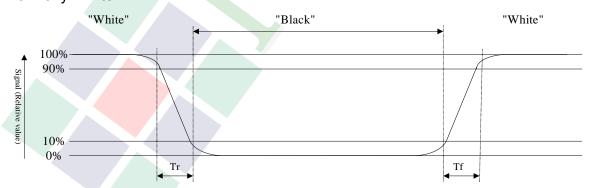
To be measured at the center area of panel with a viewing cone of 1° by Topcon luminance meter BM-7, after 10 minutes operation (module)

Note2: Definition of response time:

The output signals of photo detector are measured when the input signals are changed from "black" to "white" (falling time) and from "white" to "black" (rising time), respectively. The response time is defined as the time interval between the 10% and 90% of Amplitudes.

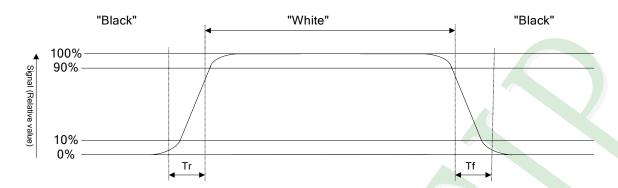
Refer to figure as below:

Normally White





Normally Black



Note3: Definition of contrast ratio:

Contrast ratio is calculated with the following formula

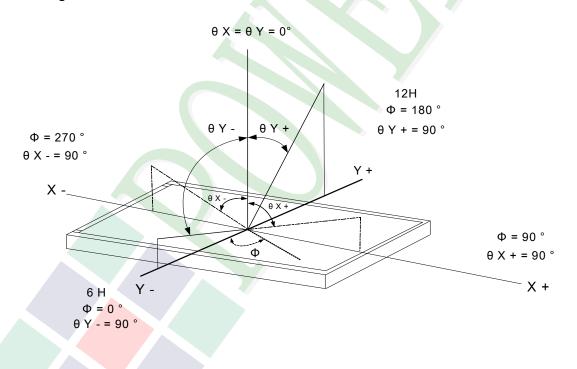
Photo detector output when LCD is at "White" state

Contrast ratio (CR) =

Photo detector output when LCD is at "Black" state

Note4: Definition of viewing angle:

Refer to figure as below:





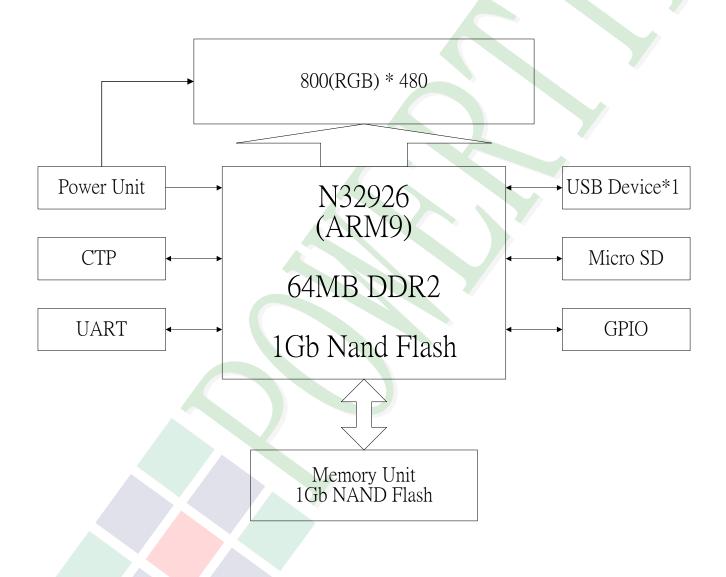
2. MODULE STRUCTURE

2.1 Counter Drawing

2.1.1 Mechanical Diagram

* See Appendix

2.1.2 Block Diagram





2.2 Interface Pin Description

J8 --- I/O

Pin No.	Symbol	Туре	DESCRIPTION	
1	GND	Р	Power ground.	
2	GPG9	Ю	General Purpose I/O, Port G[9].	
3	GPG8	Ю	General Purpose I/O, Port G[8].	
4	NC	-	Not Used.	
5	GND	Р	Power ground.	
6	NC	-	Not Used.	
7	GND	Р	Power ground.	
8	NC	-	Not Used.	
9	GND	Р	Power ground.	
10	GPG2	Ю	General Purpose I/O, Port G[2].	
11	GND	Р	Power ground.	
12	GPG4	Ю	General Purpose I/O, Port G[4].	
13	GPG5	Ю	General Purpose I/O, Port G[5].	
14	GND	P	Power ground.	
15	GPG3	Ю	General Purpose I/O, Port G[3].	
16	GND	Р	Power ground.	
17	HPOUT_L	Α	Connect to N32926 pin 102.	
18	HPOUT_R	A	Connect to N32926 pin 101.	
19	GPG7	Ю	General Purpose I/O, Port G[7].	
20	GPA11	Ю	General Purpose I/O, Port A[11].	
21	GND	Р	Power ground.	
22	RESETn	I	System reset signal input, active low.	



Pin No.	Symbol	Туре	Function
23	UART_RXD	I	UART port, receiver signal.
24	UART_TXD	0	UART port, transmitter signal.
25	GND	Р	Power ground.
26	VIN	Р	DC 5.0V Power Supply.
27	VIN	Р	DC 5.0V Power Supply.
28	NC	-	Not Used.
29	NC	-	Not Used.
30	GND	Р	Power ground.

J9 --- USB 2.0 Device Micro USB type

Pin No.	Symbol	Туре	DESCRIPTION
1	VUSB5V	Р	USB +5.0V.
2	D-	DS	Data – (Data M).
3	D+	DS	Data + (Data P).
4	NC	-	Not Used.
5	GND	Р	Ground.

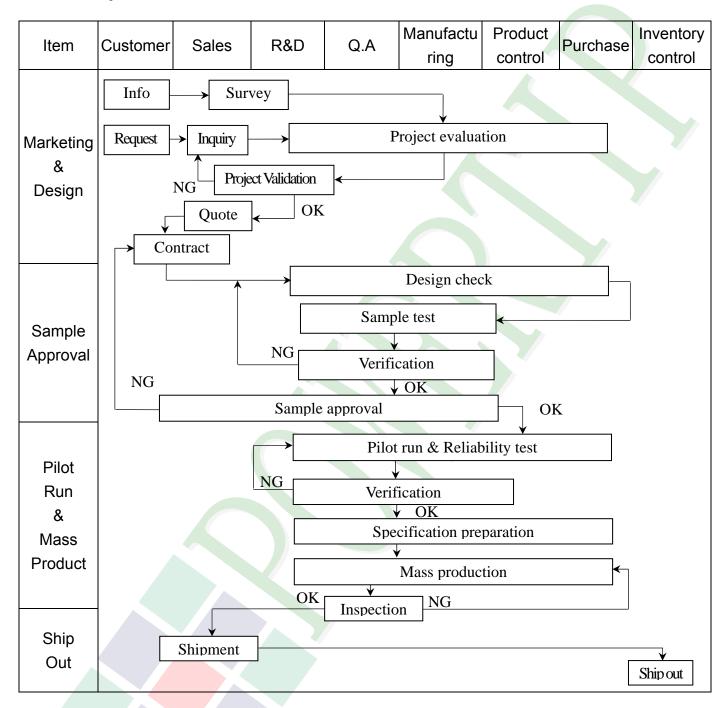
J11 --- RTC POWER

	Pin No.	Symbol	Type	Function
-	1	VBAT	Р	Power Supply for RTC.
	2	GND	Р	Ground.

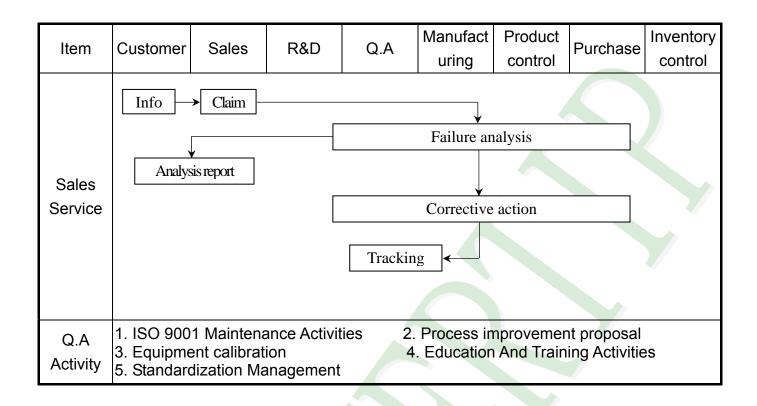


3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart









4. RELIABILITY TEST

4.1 Reliability Test Condition

NO.	TEST ITEM	TEST CONDITION
1	High Temperature Storage Test	Keep in +70 ±2°C 240 hrs Surrounding temperature, then storage at normal condition 4hrs.
2	Low Temperature Storage Test	Keep in −20 ±2°C 240 hrs Surrounding temperature, then storage at normal condition 4hrs.
3	High Temperature / High Humidity Storage Test	Keep in +60°C / 90% R.H duration for 240 hrs Surrounding temperature, then storage at normal condition 4hrs. (Excluding the polarizer)
4	Temperature Cycling Storage Test	$-20^{\circ}\text{C} \rightarrow +25^{\circ}\text{C} \rightarrow +70^{\circ}\text{C} \rightarrow +25^{\circ}\text{C}$ $(30\text{mins}) (5\text{mins}) (5\text{mins})$ $\downarrow \qquad \qquad$
5	Vibration Test (Packaged)	 Sine wave 10~55 Hz frequency (1 min) The amplitude of vibration :1, 5 mm Each direction (X \ Y \ Z) duration for 2 Hrs
6	Drop Test (Packaged)	Packing Weight (Kg) 0 ~ 45. 4 122 45. 4 ~ 90. 8 76 90. 8 ~ 454 61 0ver 454 46 Drop direction: **1 corner / 3 edges / 6 sides each 1 times



5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

5.2 HANDLING

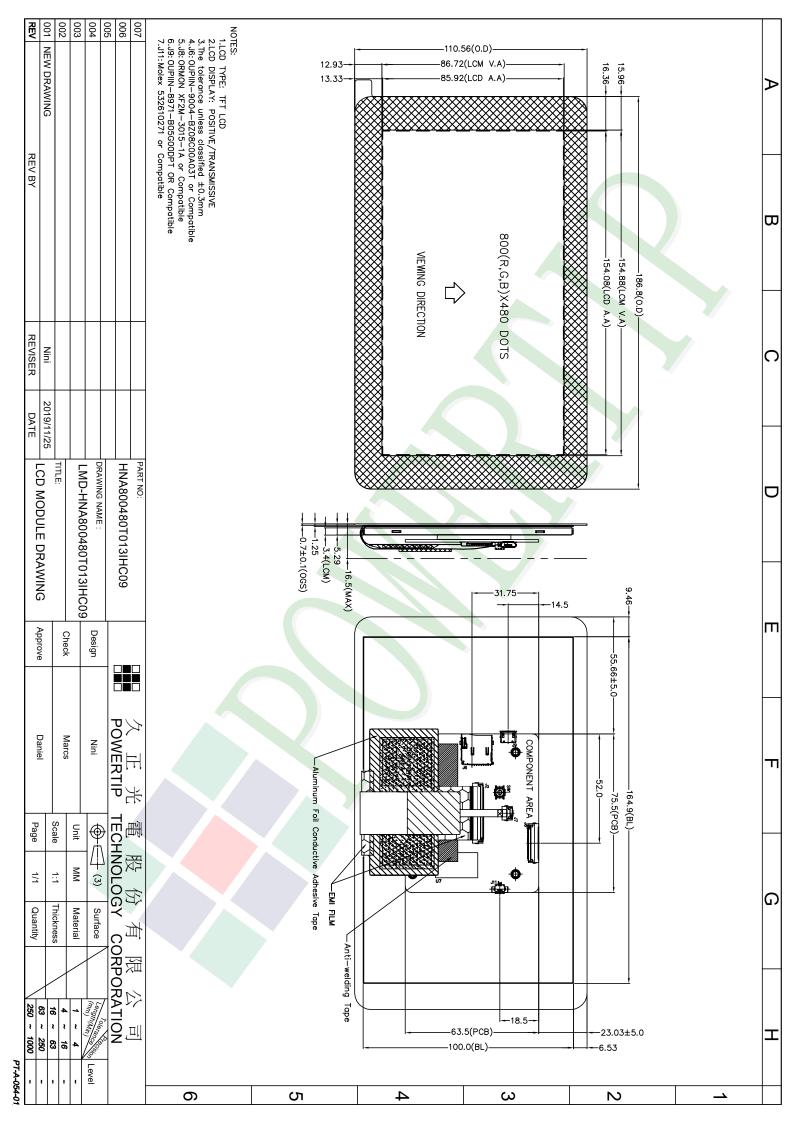
- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module, be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So, please handle it very carefully, do not touch, push or rub the exposed polarizing with anything harder than an HB pencil lead (glass, tweezers, etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands, this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is $320 \pm 10^{\circ}$ C and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM
- 5.2.10 Caution!(LCM products with Capacitive Touch Panel)
 Strong EMI-sources such as switch-mode power supplies (SMPS) can lead to touch malfunction (e.g. ghost-touches).
 - Therefore, the touch needs to be thoroughly tested inside the target application.
- 5.2.11 CAUTION: Continuously displaying same static image will result in high possibility of image sticking/image burn-in effect due to TFT panel characteristic.

5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is $25^{\circ}\text{C} \pm 5^{\circ}\text{C}$ and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush, shake, or jolt the module.

5.4 TERMS OF WARRANTY

- 5.4.1 Applicable warrant period The period is within thirteen months since the date of shipping out under normal using and storage conditions.
- 5.4.2 Unaccepted responsibility
 - This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.



Approve Check Contact Ver.001 LCM包裝規格書 LCM Packaging Specifications Daniel Marcs Nini Documents NO. PKG-HNA800480T013IHC09 (For Tray) 1.包裝材料規格表 (Packaging Material): (per carton) No. Model Dimensions (mm) 1Pcs Weight Quantity Total Weight 成品 (LCM) 1 HNA800480T013IHC09 186.8 X 110.56 24 0.2 4.8 2 多層薄膜(1)POF 4 OTFILM0BA03ABA 19"X350X0.015 3 TRAY 盤 (2)Tray TYSG000000464 352 X 260 X 25.56 16 0.13 2.08 4 舒美墊(3) EPE FOAM00000047 350 X 255 X 5 8 0.088 0.011 5 内盒(4)Product Box BX0000000022 393 X 274 X 107 0.25 4 1.0 6 OTPLB00000008 2 保利龍板(5)Polylon board 550 X 393 X 15 0.044 0.022 7 1 外紙箱(6)Carton BX57041027CCBA 570 X 410 X 265 1.0 1.0 8 9 Kg±10% 2. 一整箱總重量 (Total LCD Weight in carton): 9.01 3. 單箱數量規格表 (Packaging Specifications and Quantity): (1)LCM quantity per box : no per tray x no of trav 3 2 6 (2)Total LCM quantity in carton: quantity per box x no of boxes 6 4 24 (5)保利龍板 Polylon board Use empty tray 空盤 (3)EPE (1)多層薄膜 POF. Put products into the tray (2)TRAY 盤 (5)保利龍板 Tray Polylon board (3)EPE (4)内盒 Tray stacking Product Box (6)外紙箱 Carton 特 記 事 項 (REMARK) 斜角 Detail B Tray 2 Tray 1 4.TRAY盤相疊時,需旋轉180度,請詳見B視圖 Rotate tray 180 degrees and place on top of stack. Check the tray stack using Fig. B.